

Fair-Rite P/N **2744041447**

44 Material Grade

Nominal Chemical Composition

Supporting notes:

1. P/N 2744041447 consists of:
 - a core 44 Material Grade
 - b wire Pb- Free Plated Flat Cu Wire
2. Moisture Sensitivity Level (MSL)= 1
3. Max Reflow Temp= 260 degC
4. Max Time at Max Reflow Temp= 40 sec
5. RoHS 6/6 Compliant Terminations/ Wire are backwards compatible with standard Soldering Processes
6. RoHS Conversion Date= 1/1/2005
7. RoHS Compliance Marking is Contained on Shipping Labels

<u>Compound</u>	<u>CAS Number</u>	<u>wt %</u>	Wt of core (g)= 0.271	Compound Weight (g) Breakdown of 44 Material
Fe2O3	1309-37-1	63.97	0.1734	
ZnO	1314-13-2	21.00	0.0569	
NiO	1313-99-1	11.00	0.0298	
CuO	1317-38-0	4.00	0.0108	
Bi2O3	1304-76-3	0.03	0.0001	

Pb- Free Plated Flat Cu Wire

<u>Element</u>	<u>CAS Number</u>	<u>wt%</u>	Wt of wire (g)= 0.029	Element Weight (g) Breakdown of Pb- Free Plated Round Cu Wire
Cu	7440-50-8	93.3	0.027057	
Plating:				
Ni	7440-02-0	2.2	0.000638	
Sn	7440-31-5	4.5	0.001305	

Calculated Maximum Levels of RoHS Restricted Substances Present in 44 Material Grade

<u>Impurity Substance</u>	<u>RoHS Threshold (ppm)</u>	<u>ppm</u>	Wt of core (g)= 0.271	RoHS Impurity Substance Weight (g) Breakdown of 44 Material
Cr+6	1000	0.00	0	
Cd	100	6.09	1.65039E-06	
Hg	1000	0.09	2.439E-08	
Pb	1000	10.90	2.9539E-06	
PBB	1000	0.00	0	
PBDE	1000	0.00	0	
Bis(2-Ethylhexyl) phthalate (DEHP)	1000	0.00	0	
Benzyl butyl phthalate (BBP)	1000	0.00	0	
Dibutyl phthalate (DBP)	1000	0.00	0	
Diisobutyl phthalate (DIBP)	1000	0.00	0	